

FEATURES

| Excellent high temperature stability

Low forward voltage

Low power loss/ high efficiency

| High forward surge capability

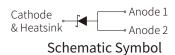
I Ideal for automated placement





APPLICATIONS

Trench Schottky barrier rectifier is designed for high frequency miniature switched mode power supplies such as adapters, lighting and on-board DC/DC converters.



APPROVALS

RoHS Compliance with 2011/65/EU

HF Compliance with IEC61249-2-21:2003

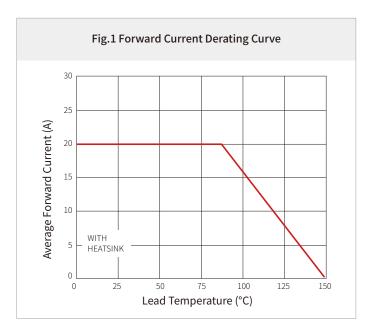
MAXIMUM RATINGS ($T_A = 25$ °C)

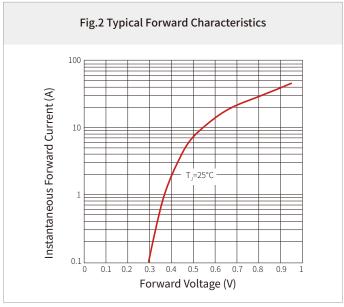
Parameter		Symbol	Value	Unit
Maximum Repetitive Peak Reverse Voltage		V_{RRM}	45	V
Maximum average forward rectified current		I _{F(AV)}	20	А
Peak forward surge current, 8.3 ms single half sine-wave superimposed on rated load per diode		I _{FSM}	300	А
Maximum instantaneous forward voltage per diode (Note 1)I _F =20A,T _J =25°C		V _F	0.52	V
Maximum instantaneous reverse current per diode at rated reverse voltage	T _J =25°C	I _R	80	μΑ
	T _J =125°C		5	mA
Typical thermal resistance		$R_{_{\theta JL}}$	11	°C/W
Operating Junction And Storage Temperature Range		T _J ,T _{STG}	-55 to 150	°C

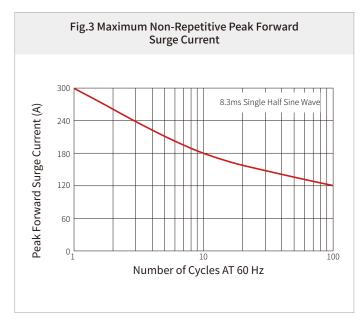
Note 1: Pulse Test with Pulse Width=300 μ s, 1% Duty Cycle

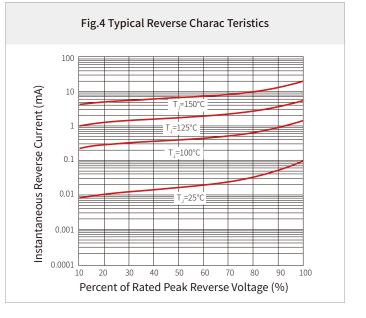


CHARACTERISTIC CURVES





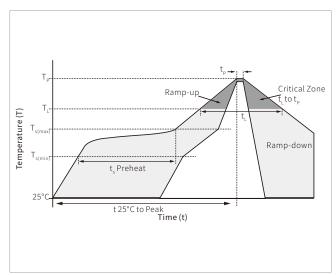




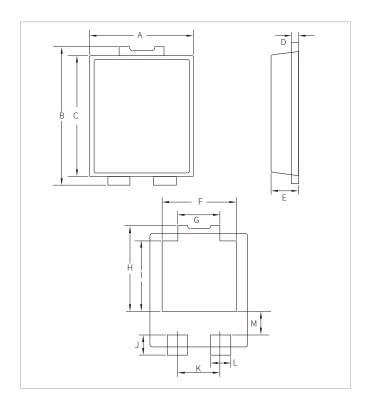


SOLDERING PARAMETERS

	Reflow Condition	Lead-free assembly	
	Temperature Max (T _{s(min)})	150°C	
Pre Heat	Temperature Max (T _{s(max)})	200°C	
	Time (min to max) (t _s)	60 – 180 secs	
Average ran	Average ramp up rate (Liquidus Temp (T_L) to peak		
	T _{S(max)} to T _L - Ramp-up Rate		
Reflow	Temperature (T _L) (Liquidus)	217°C	
Kellow	Time (min to max) (t _L)	60 – 150 seconds	
Peak Temp	erature (T _P)	260°C	
Time within	n 5°C of actual peak Temperature (t _p)	20 – 40 seconds	
Ramp-dow	n Rate	6°C/second max	
Time 25°C t	to peak Temperature (T _P)	8 minutes max.	
Do not exceed		260°C	



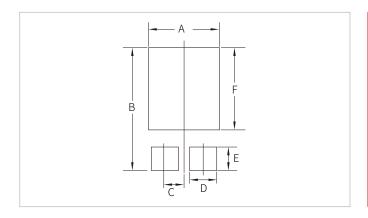
TO-277B PACKAGE INFORMATION



	Ref.	Millimeters		Inches		
		Min.	Max.	Min.	Max.	
	А	4.00	4.60	0.157	0.181	
	В	6.20	6.80	0.244	0.268	
	С	5.50	6.00	0.216	0.236	
	D	0.25	0.40	0.010	0.016	
	Е	1.05	1.35	0.041	0.053	
	F	3.00	3.50	0.118	0.138	
	G	1.70	2.00	0.067	0.079	
	Н	4.20	4.50	0.165	0.177	
	I	3.52Nom		0.139Nom		
	J	0.85	1.10	0.033	0.043	
	K	1.86Nom		0.073Nom		
	L	0.80	1.00	0.031	0.039	
	М	1.10	1.40	0.043	0.055	



RECOMMENDED PAD LAYOUT DIMENSIONS



Ref.	Millimeters		Inches	
Kei.	Min.	Max.	Min.	Max.
А	3.40	-	0.134	-
В	6.90		0.272	
С	0.95		0.037	
D	1.30	-	0.051	-
E	1.30	-	0.051	-
F	4.60	-	0.181	-

ORDERING INFORMATION

Part Number	Component Package	QTY/Reel	Reel Size
SP2045	TO-277B	5000PCS	13"



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By QR Code





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Machat

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